# BUSSMANN SERIES

# PTSA0805 Automotive SMD PTC fuses



#### **Product features**

- AEC-Q200 qualified
- Positive temperature coefficient (PTC)
- Surface mount resettable fuse
- Compact 0805 (2012 metric) footprint
- Low resistance
- Fast time-to-trip
- Current rating from 0.10 to 0.12 A
- Voltage rating 15 V

#### **Applications**

- Infotainment
- In-vehicle navigation
- Telematics
- Car lighting
- Power window and seat control
- Instrument clusters
- PCB trace protection

#### **Environmental compliance**







# Part number system/ordering: PTSA080515V010

- PT= PTC resettable fuse
- S= Surface mount
- A= Automotive
- 0805= Dimension code
- 15V= Maximum voltage
- 010= Ihold current rating (010= 0.10 A)

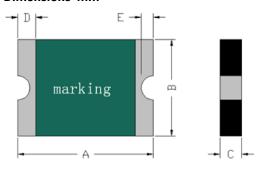


#### **Product specifications**

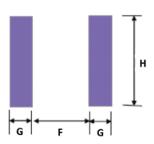
	Vmax <sup>1</sup>	lmax²	lhold³	ltrip <sup>4</sup>	Pd⁵	Time-to-trip (maximum)		Resistance <sup>6</sup>			
Part number	(V <sub>dc</sub> )	(A)	(A)	(A)	typical (W)	(A)	(seconds)	Initial (R <sub>i</sub> ) minimum (Ω)	Post trip (R <sub>1</sub> ) maximum (Ω)	Part marking	
PTSA080515V010	15	10	0.10	0.30	0.50	0.50	2.00	0.50	10.0	0	
PTSA080515V012	15	20	0.12	0.30	0.50	1.00	0.50	0.40	9.0	0	

- 1. Vmax: Maximum continuous voltage the device can withstand without damage at rated current
- 2. Imax: Maximum fault current the device can withstand without damage at rated voltage
- 3. Ihold: Maximum current the device will pass without interruption at +23 °C still air
- 4. Itrip: Minimum current that will transition the device from low resistance to high resistance at +23 °C still air
- 5. Pd: Power dissipated from the device when in tripped state at +23 °C still air
- 6. R<sub>i</sub>: Minimum resistance of the device at +23 °C
  - R<sub>1</sub>: Maximum resistance of the device one hour after tripping at +23 °C

#### Dimensions-mm



#### Recommended pad layout



Part number	A typ	A max	B typ	B max	C typ	C max	D min	E min	F	G	Н
PTSA080515V010	2.25	2.50	1.50	1.60	0.50	1.00	0.20	0.08	1.2	1.0	1.50
PTSA080515V012	2.25	2.50	1.50	1.60	0.50	1.00	0.20	0.08	1.2	1.0	1.50

## Thermal derating chart - Ihold (A)

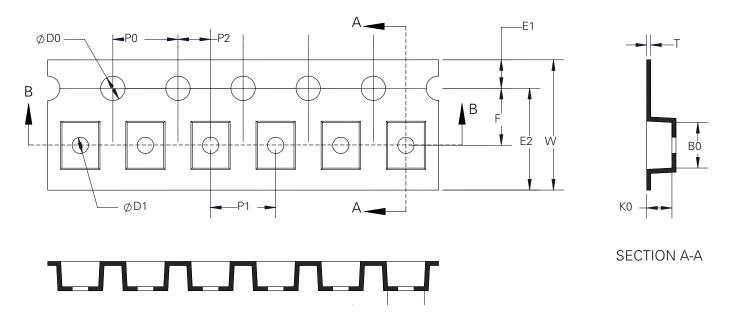
Part number	Maxii	num an	nbient 1	tempera	ture (°C	)			
Part Humber	-40	-20	0	25	40	50	60	70	85
PTSA080515V010	0.14	0.13	0.12	0.10	0.09	0.08	0.07	0.06	0.04
PTSA080515V012	0.18	0.16	0.14	0.12	0.10	0.09	0.08	0.07	0.05

## **General specifications**

Operating temperature: -40 °C to + 85 °C (with derating)
Storage temperature: -10 °C to + 40 °C
Storage relative humidity: ≤70%
Storage conditon: Keep away form corrosive atmosphere and sunlight
Passive aging: IEC60738-1 , +65 °C, 1000 hours, $\leq$ 20% IEC60738-1 , +85 °C, 1000 hours, $\leq$ 20%
Humidity aging: +85 °C, 85% RH, 100 hours, ≤ 20%
Thermal shock: IEC60738-1, +85 °C/ -40 °C, 20 cycles, $\leq$ 50%
Trip cycle life: UL1434, Vmax, Imax, 100 cycles, no arcing or burning
Trip endurance: UL1434, Vmax, Itrip ≤ I ≤ Imax, 2 hours, no arcing or burning
MSL test: J-STD-020, MSL=1, pass and no visible damage

# **Packaging information**

Supplied in tape and reel packaging, 4000 parts per 7.0" (178 mm) diameter reel (EIA-481 compliant)



w	F	E1	E2	PO	P1	P2	D0	D1	A0	BO	KO	Т
8.00 ± 0.30	3.50 ± 0.10	1.75 ± 0.10	-	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05	1.50 + 0.10/-0	-	1.68 ± 0.10	2.44 ± 0.10	1.04 ± 0.10	$0.22 \pm 0.05$

#### Solder reflow profile

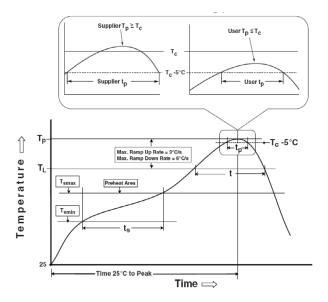


Table 1 - Standard SnPb solder (T<sub>C</sub>)

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) Free Solder (Tc)

Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

#### Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C	150 °C
Temperature max. (T <sub>smax</sub> )	150 °C	200 °C
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds
Ramp up rate T <sub>L</sub> to T <sub>p</sub>	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (TL) Time ( $t_L$ ) maintained above $T_L$	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (Tp)*	Table 1	Table 2
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	20 seconds*	30 seconds*
Ramp-down rate ( $T_p$ to $T_L$ )	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

<sup>\*</sup> Tolerance for peak profile temperature (T<sub>D</sub>) is defined as a supplier minimum and a user maximum.

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